



SPECIFICATION

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SPEC. NO.: PS-53007-XXXXX-XXX

REVISION: B

PRODUCT NAME: 2.00mm BATTERY CONN. R/A TYPE

PRODUCT NO: 53001,53002, 53003, 53004, 53007, 53008,53050,

53049,54963,54964 54967 54968 SERIES

PREPARED: BRAVE DATE: 2014.02.18	CHECKED: JERRY DATE: 2014.02.18	APPROVED: JASON DATE: 2014.02.18
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Aces P/N: **53007 SERIES**

TITLE: **2.00mm BATTERY CONN. R/A TYPE**

RELEASE DATE: 2014/02/18

REVISION: **B**

ECN No: ECN-1402129

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1 Revision History

Rev.	ECN #	Revision Description	Prepared	Date
1	ECN-1111001	NEW DRAW FOR 53007	BRAVE	2011/10/13
2	ECN-1212162	ADD 53050,53049SERIES	XHX	2012/12/17
O	ECN-1307482	RELEASE	FNEGXIAO	2013/07/30
A	ECN-1310144	ADD 54963,54964SERIES	DAVID	2013/10/22
B	ECN-1402129	ADD 549.7 54968 SERIES	BRAVE	2014/02/18

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2 SCOPE

This specification covers performance, tests and quality requirements for **2.00mm pitch Battery Conn. R/A Type**.

3 APPLICABLE DOCUMENTS

EIA-364 : ELECTRONICS INDUSTRIES ASSOCIATION

4 REQUIREMENTS

4.1 Design and Construction

- 4.1.1 Connector shall be of the design, construction and physical dimensions specified on the applicable sales drawing.
- 4.1.2 All materials conform to R.o.H.S. and the standard depends on TQ-WI-140101.

4.2 Materials and Finish

- 4.2.1 Contact: High performance copper alloy
Finish: **Pls. refer to the drawing.**
- 4.2.2 Housing: Thermoplastic or Thermoplastic High Temp., UL94V-0
- 4.2.3 Board Lock: High performance copper alloy
Finish: **Pls. refer to the drawing.**
- 4.2.4 Screw: High performance copper alloy
Finish: **Pls. refer to the drawing.**

4.3 Ratings

- 4.3.1 Voltage: **30V AC,DC**
- 4.3.2 Current: **5.0A AC,DC (per pin)**
- 4.3.3 Operating Temperature : **-40°C to +85°C**

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5 Performance

5.1. Test Requirements and Procedures Summary

Item	Requirement	Standard
Examination of Product	Product shall meet requirements of applicable product drawing and specification.	Visual, dimensional and functional per applicable quality inspection plan.
ELECTRICAL		
Item	Requirement	Standard
Low Level Contact Resistance	Initial: 20 m Ω Max. After test: 40 m Ω Max.	Mate connectors, measure by dry circuit, 20mV Max., 100mA Max. (EIA-364-23)
Insulation Resistance	500 M Ω Min.	Unmated connectors, apply 500 V DC between adjacent terminals. (EIA-364-21)
Dielectric Withstanding Voltage	No breakdown.	500 V AC Min. at sea level for 1 minute. Test between adjacent contacts of unmated connectors. (EIA-364-20)
Temperature rise	30°C Max.Change allowed	Mate connector: measure the temperature rise at rated current until temperature stable. The ambient condition is still air at 25°C (EIA-364-70,METHOD1, CONDITION1)
MECHANICAL		
Item	Requirement	Standard
Mating /Unmating Forces	Mating Force: 0.25kgf Max / per pin Unmating Force: 0.02kgf Min / per pin	Operation Speed : 25.4 $\pm$ 3 mm/minute. Measure the force required to mate/unmated connector. (EIA-364-13)

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Contact Retention Force	0.4kgf Min	Operation Speed : 25.4 ± 3 mm/minute. Measure the contact retention force with Tensile strength tester.
Lock Retention Force	0.35kgf Min	Operation Speed : 25.4 ± 3 mm/minute. Measure the contact retention force with Tensile strength tester.
Durability	5000 cycles.	The sample should be mounted in the tester and fully mated and unmated the number of cycles specified at the rate of 25.4 ± 3mm/min.
Vibration	1 μs Max.	The electrical load condition shall be 100 mA maximum for all contacts. Subject to a simple harmonic motion having amplitude of 0.76mm (1.52mm maximum total excursion) in frequency between the limits of 10 and 55 Hz. The entire frequency range, from 10 to 55 Hz and return to 10 Hz, shall be traversed in approximately 1 minute. This motion shall be applied for 2 hours in each of three mutually perpendicular directions. (EIA-364-28 Condition I)
Shock (Mechanical)	1 μs Max.	Subject mated connectors to 50G's(peak value) half-sine shock pulses of 11 milliseconds duration. Three shocks in each direction shall be applied along the three mutually perpendicular axes of the test specimen (18 shocks). The electrical load condition shall be 10mA maximum for all contacts. (EIA-364-27, test Condition A)

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ENVIRONMENTAL

Resistance to Wave Soldering Heat	See Product Qualification and Test Sequence Group 10 (Lead Free)	Solder Temp. : 265±5℃, 10±0.5sec.
Resistance to Reflow Soldering Heat	See Product Qualification and Test Sequence Group 10 (Lead Free)	Pre Heat : 150℃~180℃, 60~120sec. Heat : 230℃ Min., 40sec Min. Peak Temp. : 260℃ Max, 10sec Max.
Hand Soldering Temperature Resistance	Appearance: No damage	T ≥ 350℃ , 3sec at least.
Thermal Shock	See Product Qualification and Test Sequence Group 4	Mate module and subject to follow condition for 5 cycles. 1 cycles: -55+0/-3 ℃, 30 minutes +85 +3/-0 ℃, 30 minutes (EIA-364-32, test condition I)
Humidity	See Product Qualification and Test Sequence Group 4	Mated Connector 40℃, 90~95% RH, 96 hours. (EIA-364-31, Condition A, Method II)
Temperature life	See product Qualification and test sequence group5	Subject mated connectors to temperature life at 85℃ for 96 hours. (EIA-364-17, Test condition A)
Salt Spray (Only For Gold Plating)	See Product Qualification and Test Sequence Group 6	Subject mated/unmated connectors to 5% salt-solution concentration, 35℃ (I) Gold flash for 8 hours (II) Gold plating 5 u" for 96 hours. (EIA-364-26)
Solder ability	Tin plating: Solder able area shall have minimum of 95% solder coverage. Gold plating: Solder able area shall have minimum of 75% solder coverage	And then into solder bath, Temperature at 245 ±5℃ , for 4-5 sec. (EIA-364-52)

Note. Flowing Mixed Gas shall be conduct by customer request.

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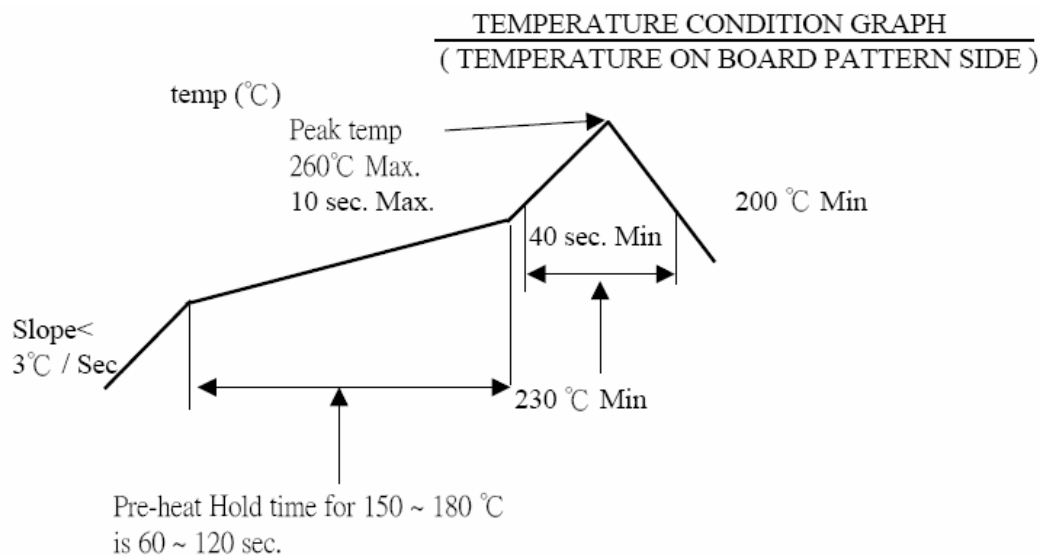
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6 INFRARED REFLOW CONDITION

6.1. Lead-free Process



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7 PRODUCT QUALIFICATION AND TEST SEQUENCE

Test or Examination	Test Group										
	1	2	3	4	5	6	7	8	9	10	11
	Test Sequence										
Examination of Product	1,3			1,7	1,6	1,4				1,4	
Low Level Contact Resistance		1,5	1,4	2,10	2,9	2,5				2,5	
Insulation Resistance				3,9	3,8						
Dielectric Withstanding Voltage				4,8	4,7						
Temperature Rise	2										
Mating / Un-mating Forces		2,4									
Contact Retention Force								1			
Durability		3									
Vibration			2								
Shock(Mechanical)			3								
Resistance to Soldering Heat										3	
Thermal Shock				5							
Humidity				6							
Temperature Life					5						
Salt Spray(Only For Gold Plating)						3					
Solder ability							1				
Lock Retention Force									1		
Hand Soldering Temperature Resistance											1
Sample Size	2	4	4	4	4	4	2	4	4	4	4